

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image





OMNIMATE[®] 4.0 - the next evolution step

OMNIMATE[®] 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- Optical and acoustic feedback indicates proper wiring
- **Create your own configuration**
- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

Simply configuration of modular hybrid connectors

• Flexible combination options for power, signal and data transmission

• Future-proof Single-Pair Ethernet technology

General ordering data

Version	PCB plug-in connector, male header, THT/THR solder connection, Pitch in mm (P): 5.00 mm, Number of poles: 2, 180°, Tube
Order No.	<u>8000072425</u>
Туре	MHS 5/02 V T3 B T
GTIN (EAN)	4064675423140
Qty.	48 pc(s).
Product data	IEC: 400 V / 25.3 A UL: 300 V / 18.5 A
Packaging	Tube

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Technical data



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Depth	11.9 mm	Depth (inches)	0.469 inch
Height	17.2 mm	Height (inches)	0.677 inch
Height of lowest version	14 mm	Width	11.38 mm
Width (inches)	0.448 inch	Net weight	1.6 g
Temperatures			
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
System specifications			
Dre du et ferrilu		Type of composition	Decard commention
Product family Mounting onto the PCB	OMNIMATE 4.0 THT/THR solder	Type of connection Pitch in mm (P)	Board connection
	connection		5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	2	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	1.0 x 1.0 mm
Solder evelet hole diameter (D)	1.4 mm	Solder evelet hole diameter tolerance (D	
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	5 mm	L1 in inches	0.197 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE 57 106	Touch-safe above the printed circuit board	Touch-safe protection acc. to DIN VDE 0470	IP 20
Protection degree	IP20	Volume resistance	≤5 mΩ
Plugging cycles	≥ 25	Plugging force/pole, max.	8.5 N
Pulling force/pole, max.	8.5 N		
Material data			
	DA OT	Calaura	h la ala
Insulating material	PA 9T	Colour	black I
Colour chart (similar)	RAL 9011	Insulating material group	1
Comparative Tracking Index (CTI)	≥ 600 V-0	Moisture Level (MSL)	-
UL 94 flammability rating Contact material	CuMg	Contact base material Contact surface	CuMg tinned
Tinning type	matt	Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C	Operating temperature, min.	-25 C -50 °C
Operating temperature, max.	100 °C		00 0
Rated data acc. to IEC			
tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	25.3 A
Rated current, max. number of poles (Tu=20°C)	20.8 A	Rated current, min. number of poles (Tu=40°C)	21.8 A
Rated current, max. number of poles (Tu=40°C)	18 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Clearance, min.	4 mm
Creepage distance, min.			

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Institute (cURus)	c R us	Certificate No. (cURus)	E60693
Rated voltage (Use group B / UL 1059) 300 V	Rated voltage (Use group D / UL 1059)	
Rated voltage (Use group F / UL 1059		Rated current (Use group B / UL 1059)	
Rated current (Use group D / UL 1059		Clearance distance, min.	4 mm
Creepage distance, min.	5 0 mm	Reference to approval values	Specifications are maximum values, details
ol 'r' /'	5.6 mm		see approval certificate.
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
Important note			
		ly with the assured properties in the data sheet	
Votes	 in accordance with IPC-A-610¹⁰C Rated current related to rated P on drawing = pitch Rated data refer only to the cobe designed in accordance w Diameter of solder eyelet D = 	by with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. The properties of the product of the pr	resp. fulfill decorative propertievaluated on request.
Notes	 in accordance with IPC-A-610¹⁰C Rated current related to rated P on drawing = pitch Rated data refer only to the cobe designed in accordance w Diameter of solder eyelet D = 	ly with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. proponent itself. Clearance and creepage distant ith the relevant application standards.	resp. fulfill decorative propertie evaluated on request.
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Approvals Approvals JL File Number Search Certificate No. (cURus) Downloads Approval/Certificate/Document of	in accordance with IPC-A-610 ^T C Rated current related to rated P on drawing = pitch Rated data refer only to the co be designed in accordance w Diameter of solder eyelet D = Long term storage of the proc UL Website E60693	ly with the assured properties in the data sheet Class 2". Further claims on the products can be of cross-section & min. No. of poles. Imponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm duct with average temperature of 50 °C and aver	resp. fulfill decorative properti evaluated on request. ces to other components are t
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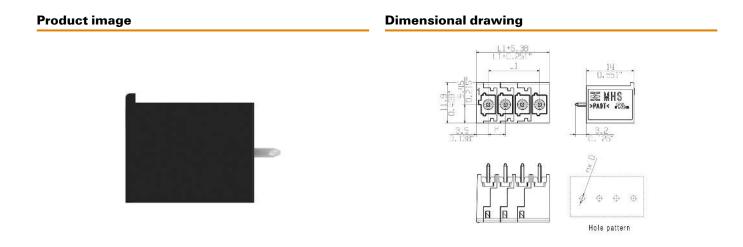
Drawings



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Catalogue status 18.08.2023 / We reserve the right to make technical changes.

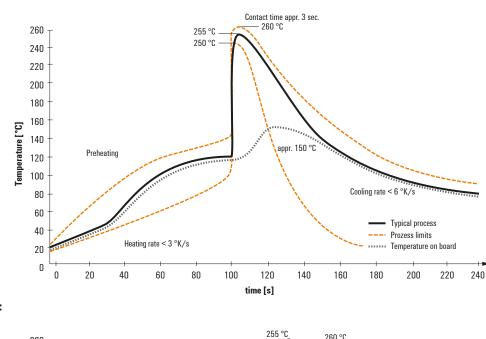
Wave Solder Profile

Recommended wave solderding profiles

Weidmüller 🟵

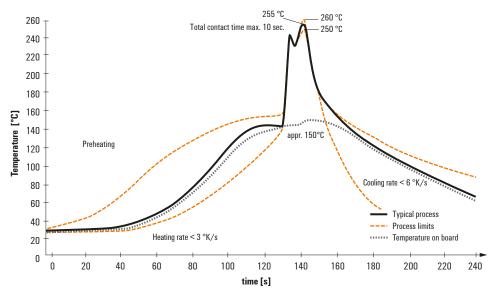
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Double Wave:

Single Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

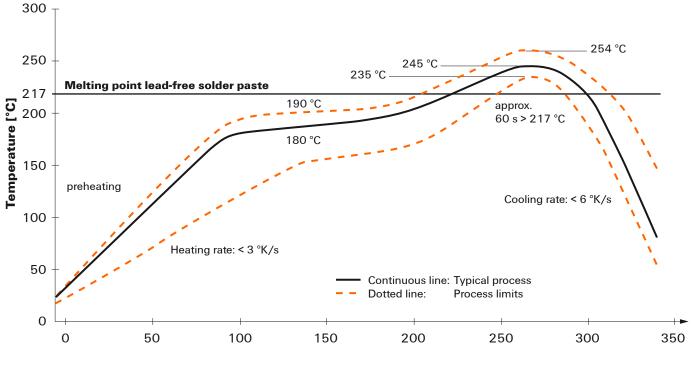
Reflow Solder Profile

Recommended reflow soldering profile



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Time [sec]

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.